

P1/9

1.Scope

This reference specification applies to Chip Ferrite Bead BLM03_SN Series.

2.Part Numbering

(ex.) <u>BL M</u>

(2) (1)

(1)Product ID (2)Type (3)Dimension(L×W) (4)Characteristics (5)Typical Impedance at 100MHz (6)Performance (7)Category (8)Numbers of Circuit (9)Packaging(D:Taping / B:Bulk)

3.Rating

Customer	MURATA	Impedance (at 100MHz,Unde) Testing		Rat Curr (m			sistance nax.) Values	Remark
Part Number	Part Number		Typical		at 125°C	Values	After Testing	
	BLM03AG100SN1D	5 to 15	10	50	00	0.1	0.15	
	BLM03AG100SN1B	51015	10	50		0.1	0.15	
	BLM03AG700SN1D	40 to 100	70	20	00	0.4	0.5	
	BLM03AG700SN1B		10	20	,0	0.1	0.0	
	BLM03AG800SN1D	80±25%	80	20	00	0.4	0.5	
	BLM03AG800SN1B	00_2070				0.1	0.0	
	BLM03AG121SN1D	120±25%	120	20	00	0.5	0.6	
	BLM03AG121SN1B	12022070	120			0.0	0.0	
	BLM03AG241SN1D	240±25%	240	20	00	0.8	0.9	
	BLM03AG241SN1B							
	BLM03AG601SN1D	600±25%	600	10	00	1.5	1.6	
	BLM03AG601SN1B							For
	BLM03AG102SN1D	1000±25%	1000	10	00	2.5	2.6	general
	BLM03AG102SN1B							use
	BLM03AX100SN1D	5~15	10	1000	0.05 0.10			
	BLM03AX100SN1B							
	BLM03AX800SN1D	80±25%	80	5	00	0.18	0.23	
	BLM03AX800SN1B							
	BLM03AX121SN1D	$120 \pm 25\%$	120	4	50	0.23	0.28	
	BLM03AX121SN1B							
	BLM03AX241SN1D	$240 \pm 25\%$	240	3	50	0.38	0.43	
	BLM03AX241SN1B							
	BLM03AX601SN1D	$600 \pm 25\%$	600	2	50	0.85	0.90	
	BLM03AX601SN1B							
	BLM03AX102SN1D	$1000 \pm 25\%$	1000	2	00	1.25	1.30	
	BLM03AX102SN1B					-		
	BLM03PG220SN1D	22±25%	22	90	00	0.065	0.115	
	BLM03PG220SN1B							
	BLM03PG330SN1D	33±25%	33	75	50	0.090	0.140	
	BLM03PG330SN1B							
	BLM03PX220SN1D	$22 \pm 25\%$	22	1800 ^{*1}	1450 ^{*1}	0.040	0.045	
	BLM03PX220SN1B	_				010.0	0.0.0	For DC
	BLM03PX330SN1D	33±25%	33	1500 ^{*1}	1200 ^{*1}	0.055	0.060	power Line
	BLM03PX330SN1B					0.000		
	BLM03PX800SN1D	80±25%	80	1000 ^{*1}	800 ^{*1}	0.130	0.135	
	BLM03PX800SN1B			1000	000	0.100	0.100	
	BLM03PX121SN1D	120±25%	120	900 ^{*1}	700 ^{*1}	0.160	0.210	
	BLM03PX121SN1B		.20			0.100	0.210	

Reference On

-0020AH-01						P2/9
Customer MURATA Part Number Part Number		Impedance (Ω) (at 100MHz,Under Standard Testin <u>g</u> Condition)				Remark
r art Number		Typical	at 85°C at 125°C	Values	After Testing	
BLM03BB100SN1D BLM03BB100SN1B	10±25%	10	300	0.4	0.5	
BLM03BB220SN1D BLM03BB220SN1B	22±25%	22	200	0.5	0.6	
BLM03BB470SN1D BLM03BB470SN1B	47±25%	47	200	0.7	0.8	
BLM03BB750SN1D BLM03BB750SN1B	75±25%	75	200	1.0	1.1	
BLM03BB121SN1D BLM03BB121SN1B	120±25%	120	100	1.5	1.6	
BLM03BC330SN1D BLM03BC330SN1B	33±25%	33	150	0.85	0.90	
BLM03BC560SN1D BLM03BC560SN1B	56±25%	56	100	1.05	1.10	
BLM03BC800SN1D BLM03BC800SN1B	80±25%	80	100	1.40	1.45	For high speed signal Line
BLM03BD750SN1D BLM03BD750SN1B	75±25%	75	300	0.4	0.5	
BLM03BD121SN1D BLM03BD121SN1B	120±25%	120	250	0.5	0.6	
BLM03BD241SN1D BLM03BD241SN1B	240±25%	240	200	0.8	0.9	
BLM03BD471SN1D BLM03BD471SN1B	470±25%	470	215	1.5	1.6	
BLM03BD601SN1D BLM03BD601SN1B	600±25%	600	200	1.7	1.8	
BLM03BX102SN1D BLM03BX102SN1B	1000±25%	1000	170	1.70	1.75	
BLM03BX182SN1D	1800±25%	1800	140	2.50	2.55	
	MURATA Part Number	MURATA Part NumberImpedance (at 100MHz,Under Testing)BLM03BB100SN1D BLM03BB100SN1B10±25%BLM03BB220SN1D BLM03BB220SN1D22±25%BLM03BB470SN1D BLM03BB470SN1D47±25%BLM03BB470SN1D BLM03BB750SN1D75±25%BLM03BB121SN1D BLM03BB121SN1D120±25%BLM03BB121SN1D BLM03BC560SN1D33±25%BLM03BC560SN1D BLM03BC560SN1D33±25%BLM03BC560SN1D BLM03BC560SN1D30±25%BLM03BC560SN1D BLM03BD750SN1B120±25%BLM03BD750SN1D BLM03BD750SN1D120±25%BLM03BD750SN1D BLM03BD121SN1D120±25%BLM03BD750SN1B BLM03BD471SN1D240±25%BLM03BD411SN1D BLM03BD411SN1D470±25%BLM03BD411SN1D BLM03BD411SN1D600±25%BLM03BD411SN1D BLM03BD411SN1D1000±25%BLM03BD601SN1D BLM03BD601SN1B1000±25%BLM03BX102SN1B1000±25%BLM03BX102SN1B1800±25%	$\begin{array}{c c c c c c c } & & & & & & & & & & & & & & & & & & &$	$\begin{array}{c c c c c c c c } & \operatorname{Impedance}\left(\Omega\right) & \operatorname{Rated} & \operatorname{Current} & (\operatorname{mA}) \\ \hline & Typical & at 85^{\circ}C & at 125^{\circ}C \\ \hline & Typical & at 85^{\circ}C & at 125^{\circ}C \\ \hline & Typical & at 85^{\circ}C & at 125^{\circ}C \\ \hline & Typical & at 85^{\circ}C & at 125^{\circ}C \\ \hline & Typical & at 85^{\circ}C & at 125^{\circ}C \\ \hline & Typical & at 85^{\circ}C & 22 \\ \hline & 10 & 30^{\circ}C \\ \hline & SUM03BB100SN1D & 22\pm25^{\circ} & 22 \\ \hline & SUM03BB220SN1D & 22\pm25^{\circ} & 22 \\ \hline & SUM03BB470SN1D & 47\pm25^{\circ} & 47 & 2^{\circ}C \\ \hline & SUM03BB470SN1D & 75\pm25^{\circ} & 75 & 2^{\circ}C \\ \hline & SUM03BB750SN1D & 75\pm25^{\circ} & 120 & 1^{\circ}C \\ \hline & SUM03BB121SN1D & 120\pm25^{\circ} & 120 & 1^{\circ}C \\ \hline & SUM03BC30SN1D & 33\pm25^{\circ} & 33 & 3^{\circ}C \\ \hline & SUM03BC560SN1D & 56\pm25^{\circ} & 56 & 1^{\circ}C \\ \hline & SUM03BC560SN1D & 56\pm25^{\circ} & 56 & 1^{\circ}C \\ \hline & SUM03BC560SN1D & 80\pm25^{\circ} & 80 & 1^{\circ}C \\ \hline & SUM03BC750SN1D & 75\pm25^{\circ} & 75 & 3^{\circ}C \\ \hline & SUM03BD750SN1D & 120\pm25^{\circ} & 120 & 2^{\circ}C \\ \hline & SUM03BD121SN1D & 120\pm25^{\circ} & 120 & 2^{\circ}C \\ \hline & SUM03BD241SN1D & 240\pm25^{\circ} & 240 & 2^{\circ}C \\ \hline & SUM03BD411SN1D & 240\pm25^{\circ} & 470 & 2^{\circ}C \\ \hline & SUM03BD41SN1D & 470\pm25^{\circ} & 600 & 2^{\circ}C \\ \hline & SUM03BD41SN1D & 600\pm25^{\circ} & 600 & 2^{\circ}C \\ \hline & SUM03BD601SN1D & 00\pm25^{\circ} & 1000 & 1^{\circ}C \\ \hline & SUM03BD601SN1D & 1000\pm25^{\circ} & 1000 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1B & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline & SUM03BX102SN1D & 1800\pm25^{\circ} & 1800 & 1^{\circ}C \\ \hline &$	$\begin{array}{c c c c c c c } & \begin{tabular}{ c c c c c } & \begin{tabular}{ c c c c } & \begin{tabular}{ c c c c } & \begin{tabular}{ c c c c c c } & \begin{tabular}{ c c c c c c c } & \begin{tabular}{ c c c c c c c } & \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	$ \begin{array}{ c c c c c } \mbox{MURATA} \\ \mbox{Part Number} \\ \hline \mbox{Mumber} \\ \hline \mbox{Multical 100MHz,Under Standard} \\ \mbox{Typical at 85°C} \\ \mbox{at 125°C} \\ \mbox{at 125°C} \\ \mbox{at 125°C} \\ \hline \mbox{Multical Number} \\ \hline \mbox{Multical Number Number} \\ \hline \mbox{Multical Number} \\ \hline \mbox{Multical Number} \\ \hline \mbox{Multical Number} \\ \hline \mbox{Multical Number Number} \\ \hline Multical Number Number$

■Operating Temperature : -55°C to +125°C

(Note) As for the Rated current marked with *1, Rated Current is derated as right figure depending on the operating temperature.



4. Style and Dimensions





: Electrode (in mm) Equivalent Circuit

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Resistance element becomes dominant at high frequencies.

Unit Mass(Typical value) 0.3mg

5.Marking No marking.



6.Standard Testing Conditions

< Unless otherwise specified > Temperature : Ordinary Temp. (15 °C to 35 °C) Humidity : Ordinary Humidity (25%(RH) to 85%(RH)) < In case of doubt > Temperature : 20°C±2 °C Humidity : 60%(RH) to 70%(RH) Atmospheric pressure : 86kPa to 106kPa

7.Specifications

<u>(-1.Ele</u>	ectrical Perform	ance	
No.	Item	Specification	Test Method
7-1-1	Impedance	Meet item 3.	Measuring Frequency : 100MHz±1MHz Measuring Equipment : KEYSIGHT4291A or the equivalent Test Fixture : KEYSIGHT16192A or the equivalent
7-1-2	DC Resistance	Meet item 3.	Measuring Equipment : Digital multi meter * Except resistance of the Substrate and Wire

7-2.Mechanical Performance

No.	Item	Specification	Test Method
	Appearance and Dimensions	Meet item 4.	Visual Inspection and measured with Measuring Microscope.
7-2-2	Bending Strength	Meet Table 1. <u>Table 1</u> <u>Appearance</u> No damage Impedance Change Within ±30% (at 100MHz) DC Resistance Meet item 3.	It shall be soldered on the Glass-epoxy substrate. Substrate : 100mm×40mm×0.8mm Deflection : 1.0mm Speed of Applying Force : 0.5mm/s Keeping Time : 30s Pressure jig Pressure jig Deflection 45mm
7-2-3	Vibration		It shall be soldered on the substrate. Oscillation Frequency : 10Hz to 55Hz to 10Hz for 1 min Total Amplitude : 1.5mm Testing Time : A period of 2 hours in each of 3 mutually perpendicular directions. (Total 6 h)
7-2-4	Resistance to Soldering Heat		Pre-Heating : $150^{\circ}C \pm 10^{\circ}C$, $60s \sim 90s$ Solder : Sn-3.0Ag-0.5Cu Solder Temperature : $270^{\circ}C\pm 5^{\circ}C$ Immersion Time : $10s\pm 0.5s$ Immersion and emersion rates : $25mm/s$ Then measured after exposure in the room condition for $48h\pm 4h$.
7-2-5	Solderability	The electrodes shall be at least 95% covered with new solder coating.	Flux : Ethanol solution of rosin,25(wt)% Pre-Heating : $150^{\circ}C \pm 10^{\circ}C$, $60s \sim 90s$ Solder : Sn-3.0Ag-0.5Cu Solder Temperature : $240^{\circ}C\pm5^{\circ}C$ Immersion Time : $3s\pm1s$ Immersion and emersion rates : 25 mm/s



No.	Item	Specification	Test Method
7-3-1	Temperature Cycle	Meet Table 1.	1 cycle : 1 step : -55 °C(+0 °C,-3 °C) / 30min±3min 2 step : Ordinary temp. / 10min to 15min 3 step : +125 °C(+3 °C,-0 °C) / 30min±3min 4 step : Ordinary temp. / 10min to 15min Total of 100 cycles Then measured after exposure in the room condition for 48h±4h.
7-3-2	Humidity		Temperature : 40°C±2°C Humidity : 90%(RH) to 95%(RH) Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-3	Heat Life		Temperature : 125°C±3°C Applying Current : Rated Current (at 125°C) Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-4	Cold Resistance		Temperature : -55±2°C Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.

8.Specification of Packaging

8-1.Appearance and Dimensions (8mm-wide paper tape)



(1)Taping

Products shall be packaged in the cavity of the base tape of 8mm-wide, 2mm-pitch continuously and sealed by cover tape .

(2)Sprocket hole: The sprocket holes are to the right as the tape is pulled toward the user.

(3)Spliced point: The base tape and cover tape have no spliced point

(4)Cavity:There shall not be burr in the cavity.

(5)Missing components number

Missing components number within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

8-2. Tape Strength

(1)Pull Strength

Cover tape	5N min.
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(2)Peeling off force of Cover tape 0.1N to 0.6N (Minimum value is typical.) *Speed of Peeling off:300mm/min



8-3. Taping Condition

(1)Standard quantity per reel				
	Quantity per 180mm reel	15000 pcs. / reel		

(2)There shall be leader-tape(top tape and empty tape) and trailer- tape(empty tape) as follows.

(3)On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.

(4) Marking for reel

The following items shall be marked on a label and the label is stuck on the reel.

(Customer part number, MURATA part number, Inspection number(*1), RoHS marking(*2), Quantity, etc)

Reference On

 *1) « Expression of Inspection 	on No. »	$\frac{\square}{(1)} \frac{OOOO}{(2)} \frac{\times \times \times}{(3)}$
(1) Factory Code		
(2) Date	First digit	: Year / Last digit of year
	Second digit	: Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O,N,D
	Third, Fourth o	digit : Day
(3) Serial No.		
*2) « Expression of RoHS n	narking »	ROHS – <u>Y</u> (<u>△</u>)

(1) RoHS regulation conformity parts.

(2) MURATA classification number

(5) Outside package

These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

(1) (2)

(Customer name, Purchasing Order Number, Customer Part Number, MURATA part number, RoHS marking(*2), Quantity, etc)

(6)Dimensions of reel and taping(leader-tape, trailer-tape)



8-4. Specification of Outer Case



Outer Case Dimensions (mm)		nsions	Standard Reel Quantity in Outer Case	
W	D	Н	(Reel)	
186	186	93	5	

* Above Outer Case size is typical. It depends on a quantity of an order.



9. 🕂 Caution

9-1.Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the surge current.

9-2. Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high

reliability for the prevention of defects which might directly cause damage to the third party's life, body or property. (6)Disaster prevention / crime prevention equipment

- (1)Aircraft equipment
- (2)Aerospace equipment
- (3)Undersea equipment (4)Power plant control equipment
- (7)Traffic signal equipment

(8)Transportation equipment (vehicles, trains, ships, etc.)

(9) Data-processing equipment

(5)Medical equipment

(10)Applications of similar complexity and /or reliability

requirements to the applications listed in the above

9-3. Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

10. Notice

Products can only be soldered with reflow.

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

10-1.Land pattern designing

Standard land dimensions (Reflow soldering)

< For BLM03 series (except BLM03PG, BLM03PX, BLM03AX type) >



1	Туре	а	b	С
	BLM03 (except 03PG, PX, AX Type)	0.25	0.80	0.30
Solde	er Resist			(in mm)
Patte	rn			

< For BLM03PG, BLM03PX, BLM03AX type >



Rated Current	а	b	с		oad thic dimensi	
(A)				18µm	35µm	70µm
max.0.9	0.05	0.00	0.00	0.3	0.3	0.3
max.1.8	0.25	0.80	0.30	1.2	0.7	0.3
					(in)	~~~ \

(in mm)

*The excessive heat by land pads may cause deterioration at joint of products with substrate.



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10-2.Soldering Conditions

(1) Flux, Solder

Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding $0.2(wt)\%$.) Do not use water-soluble flux.
Solder	Use Sn-3.0Ag-0.5Cu solder Standard thickness of solder paste : 100 μm to 150 μm

(2) Soldering conditions

• Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

- Standard soldering profile and the limit soldering profile is as follows.
- The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.



	Standard Profile	Limit Profile
Pre-heating	150~180°C 、90s±30s	
Heating	above 220°C、30s~60s	above 230°C、60s max.
Peak temperature	245±3°C	260°C,10s
Cycle of reflow	2 times	2 times

10-3. Reworking with soldering iron

- Pre-heating: 150°C, 1 min
- Soldering iron output: 80W max.
- Tip temperature: 350° C max. Tip diameter: ϕ 3mm max.
- Soldering time : 3(+1,-0) seconds. Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

10-4.Solder Volume

Solder shall be used not to be exceeded as shown below.



Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.



10-5. Attention regarding P.C.B. bending

The following shall be considered when designing and laying out P.C.B.'s.

(1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage.



Products shall be located in the sideways direction (Length:a<b) to the mechanical stress.

(2)Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board. It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

Contents of Measures	Stress Level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C



*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

(3) Mounting Components Near Screw Holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.



10-6.Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

10-7. Cleaning

When cleaning this product, observe the following conditions.

Any cleaning may cause deterioration in the quality of the product, so please check the quality of this product before use.

(1) The cleaning temperature shall be 60°C max. If isopropyl alcohol (IPA) is used, the cleaning temperature shall be 40°C max.

- (2) When ultrasonic cleaning is used, under some cleaning conditions, the substrate could resonate and the substrate vibrations could result in chip cracks, solder breakage, and other problems. Be sure to always
- perform a test cleaning beforehand using an actual cleaning device, and then check the quality of the products. (3) Cleaner
 - Alcohol-based cleaner: IPA

Aqueous agent: PINE ALPHA ST-100S

- (4) There shall be no residual flux or residual cleaner.
 - When using aqueous agent, rinse the product with deionized water adequately and completely dry it so that no cleaner is left.
 - * For other cleaning, please consult our technical department.

10-8. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

(1) in the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc.

- (the sea breeze, Cl₂, H₂S, NH₃, SO₂, NO₂,etc)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.

10-9. Resin coating

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

10-10. Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.



10-11. Storage Conditions

(1)Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

- (2)Storage conditions
 - Products should be stored in the warehouse on the following conditions.
 - Temperature : -10°C to 40°C
 - Humidity : 15% to 85% relative humidity
 - No rapid change on temperature and humidity
 - Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
 - Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
 - Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
 - Avoid storing the product by itself bare (i.e.exposed directly to air).

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

11 . <u>/</u> Note

- (1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.